

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Jun-Pyo HONG</td> <td>04/19/2012</td> </tr> <tr> <td>Seung-Hyun OH</td> <td>04/19/2012</td> </tr> <tr> <td>Ki-Choon LEE</td> <td>04/10/2012</td> </tr> </tbody> </table>		Name	Execution Date	Jun-Pyo HONG	04/19/2012	Seung-Hyun OH	04/19/2012	Ki-Choon LEE	04/10/2012				
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PROPERTY NUMBERS Total: 1													
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CORRESPONDENCE DATA													
Fax Number:	(860)286-0115												
Phone:	860-286-2929												
Email:	usptopatentmail@cantorcolburn.com												
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i>													
Correspondent Name:	CANTOR COLBURN LLP												

OP \$40.00 13469285

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ATTORNEY DOCKET NUMBER:	SHN0097US
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NAME OF SUBMITTER:	Jaegyoo Jang
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ASSIGNMENT

WHEREAS We, HONG, Jun-Pyo of 409-1401 Samsung4cha Apt., Gongduk-dong, M apo-gu, Seoul 121-020, Korea, OH, Seung-Hyun of 103-1103 Woncheonmaulpurugio Apt., Dongcheon-dong, Suji-gu, Yongin, Gyeonggi-do 448-120, Korea and LEE, Ki-Choon of 103-903 Cheongsolwoosung Apt., Dapshipri-dong, Dongdaemun-gu, Seoul 130-030, Korea (herei nafter referred to as "ASSIGNORS"); have invented certain new and useful improvements in:

**WiFi APPARATUS FOR WIRELESS INTERNET AND WIRELESS INTERNE
T SYSTEM USING THE SAME,**


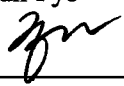
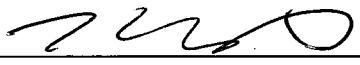
which claims priority to Korean Application No. 10-2011-0114173 filed on 3 November 2011, and for which We are about to file an application for Letters Patent of the United States;

AND WHEREAS, LG Uplus Corp., a corporation organized and existing under the laws of Korea, having a place of business at 827 Namdaemunno5-ga, Jung-gu, Seoul 100-095, Korea and EMC TECH CO., LTD., a corporation organized and existing under the laws of Korea, having a place of business at 206 Gayang Techno Town, 1487 Gayang-dong, Gangseo-gu, Seoul 157-200, Korea (hereinafter referred to as "ASSIGNEES"); are desirous of acquiring an interest in the United States and all foreign countries, in and to the said invention and Letters Patent to be obtained therefor;

NOW THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that, for good and valuable consideration, the receipt of which is hereby acknowledged, We, the said ASSIGNORS have assigned and transferred, and hereby assign and transfer unto the said ASSIGNEES, the entire right, title and interest in and to said invention in the United States and in all foreign countries, including priority rights, as fully set forth and described in said application; and We do hereby authorize and request the Commissioner of Patents to issue said Letters Patent on said application, and any and all Letters Patent that may be issued upon any and all revivals, refilings, continuations, continuations-in-part, divisions and reissues thereof, to the said ASSIGNEES, an assignee of the entire right, title and interest in and to the same, for the sole use and behoof of ASSIGNEES, its successors and assigns; and We do hereby agree that the said ASSIGNEES, may apply for foreign Letters Patent on said invention and that We

will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by the said ASSIGNEES, its successors or assigns, and that We will, at the cost and expense of the said ASSIGNEES fully assist and cooperate in all matters in connection with the United States and foreign applications and patents issuing thereon.

The undersigned declare that all statements made herein of their own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date: <u>Apr. 19. 2012</u>	 _____ L.S.
Date: <u>Apr. 19. 2012</u>	 _____ L.S.
Date: <u>10/4/2012</u>	 _____ L.S.